

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	40533	packag\$3 with substrate	US-PGPU B; USPAT; EPO; JPO	OR	ON	2005/02/22 16:02
L2	19070	1 and via	US-PGPU B; USPAT; EPO; JPO	OR	ON	2005/02/22 16:03
L3	9582	2 and insulat\$	US-PGPU B; USPAT; EPO; JPO	OR	ON	2005/02/22 16:03
L4	7969	3 and metal	US-PGPU B; USPAT; EPO; JPO	OR	ON	2005/02/22 16:04
L5	1625	4 and opening	US-PGPU B	OR	ON	2005/02/22 16:04
L6	433	5 and photoresist	US-PGPU B	OR	ON	2005/02/22 16:06
L7	343	6 and pad	US-PGPU B	OR	ON	2005/02/22 16:06
L8	13	6 and (pad near4 isolat\$3)	US-PGPU B	OR	ON	2005/02/22 16:11
L9	273	6 and plating	US-PGPU B	OR	ON	2005/02/22 16:12